



YETDA INDUSTRY LTD.

Technical Data Sheet

MODEL NO : 195UR/UYG4

0605Package 1.5*1.6mm Chip LEDs

Features :

- Package in 8mm tape on 7" diameter reel
- Compatible with automatic placement equipment
- Compatible with reflow solder process

Applications :

- Indicators
- Automotive : backlighting in dashboard and switch
- Backlight for LCD

Dice material	Emitted color	Lens Color
GaAlAs	Red	Water Clear
GaP	Green	

Electrical/Optical Characteristics(Ta=25°C)

Parameter	Test Condition	Symbol	Value			Unit	
			Min	Typ	Max		
Wavelength at peak emission	If=20mA	λ_{peak}	R	650	660	670	nm
			G	560	565	570	
Spectral half bandwidth	If=20mA	$\Delta \lambda$	R		25		nm
			G		30		
Dominant wavelength	If=20mA	λ_{dom}	R		650		nm
			G		573		
Forward voltage	If=20mA	Vf	R		1.8	2.3	V
			G		2.2	2.7	
Luminous intensity	If=20mA	Iv	R	75	110		mcd
			G	40	60		
Viewing angle at 50% Iv	If=10mA	$2\theta_{1/2}$			140		Deg
Reverse current	Vr=5V	Ir				10	μA

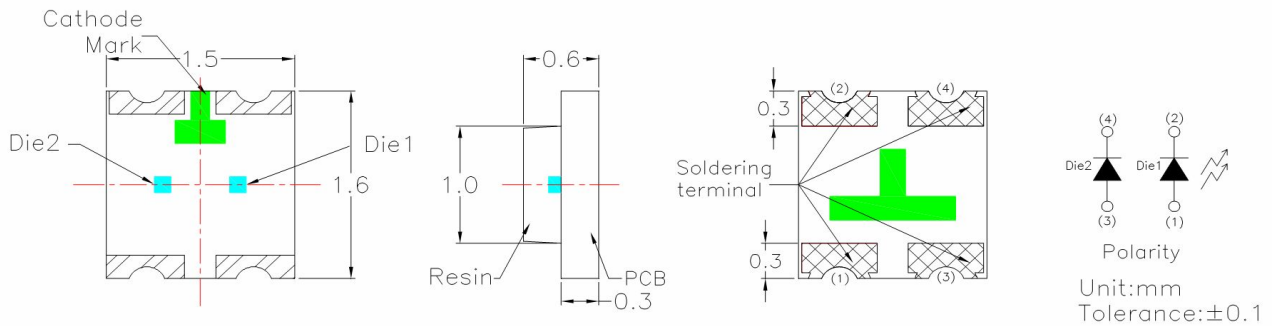


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Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Value		Unit
		R	G	
Power dissipation	Pd	69	81	mW
Forward current	If	30		mA
Reverse voltage	Vr	5		V
Operating temperature range	Top	-40 ~+80		°C
Storage temperature range	Tstg	-40 ~+85		°C
Peak pulsing current (1/8 duty f=1kHz)	Ifp	125		mA

PACKAGING DIMENSIONS

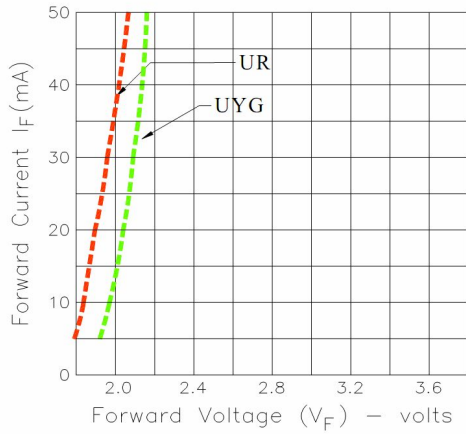


Unit:mm

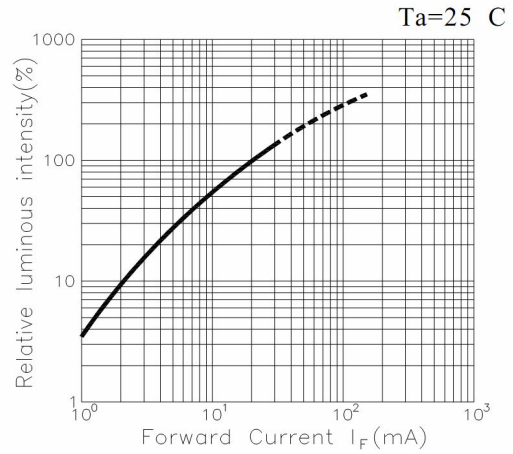


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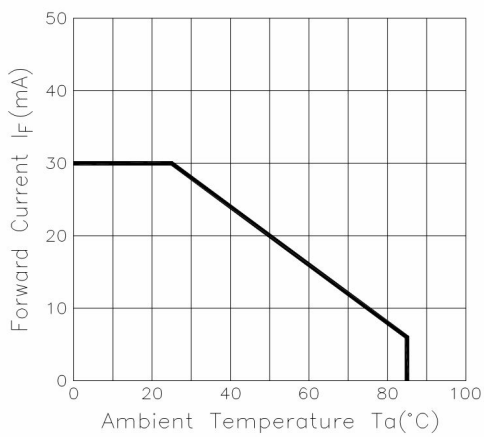
Forward Current Vs. Forward Voltage



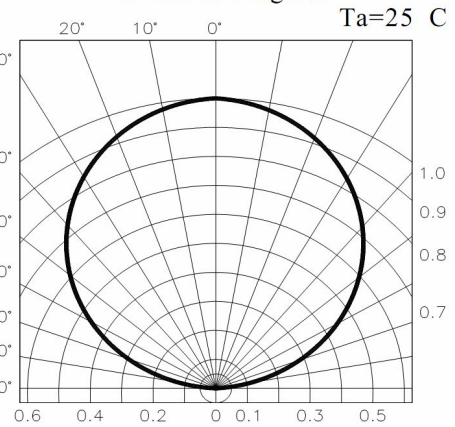
Luminous Intensity Vs. Forward Current



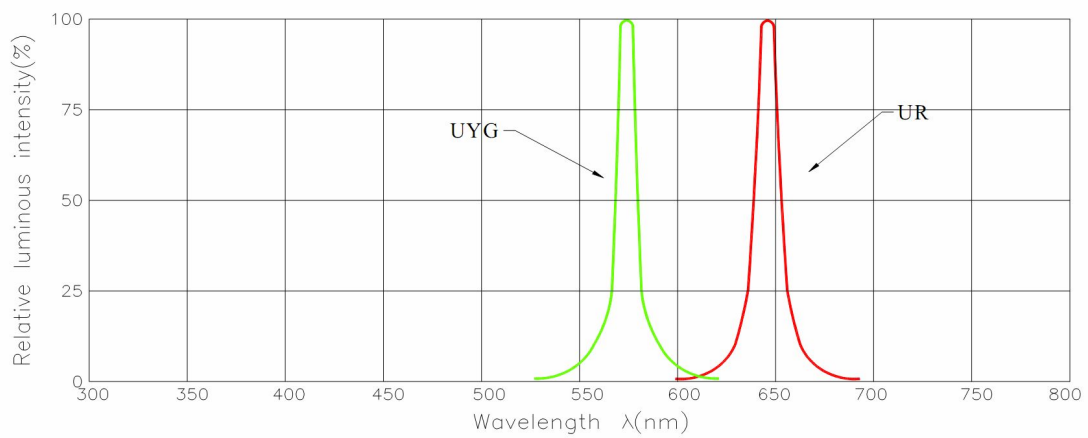
Forward Current Derating Curve



Radiation Diagram



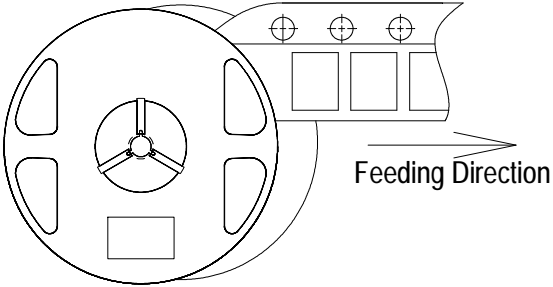
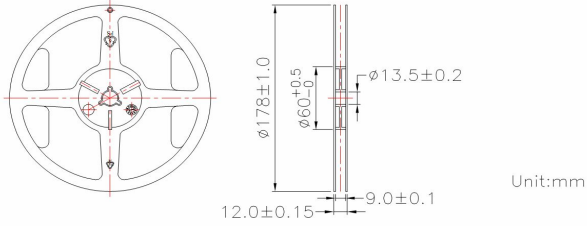
Spectrum Distribution

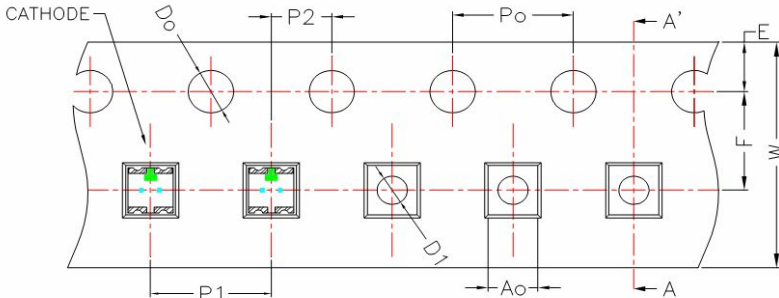
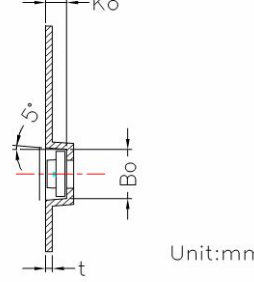


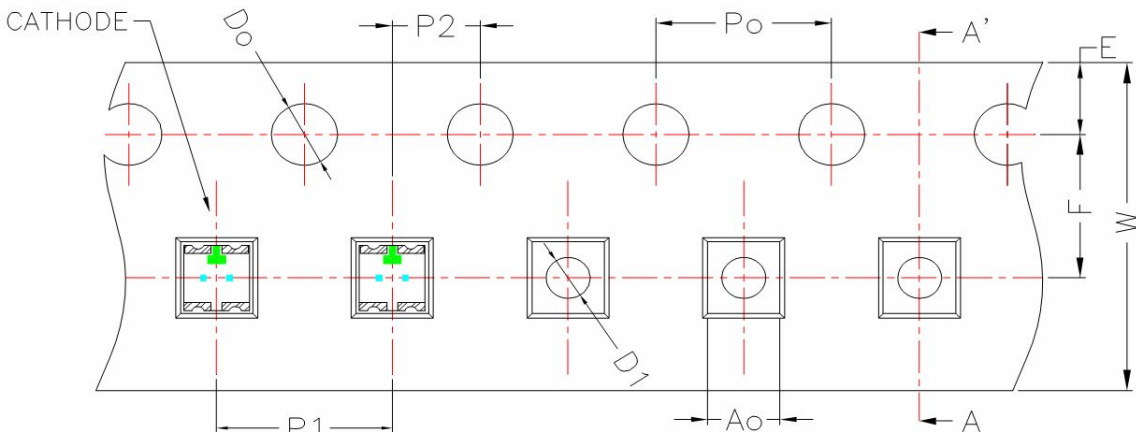


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PACKAGING SPECIFICATIONS

Feeding Direction	Dimensions of Reel (Unit: mm)
	

Dimensions of Tape (Unit: mm)	
	

Arrangement of Tape	
	

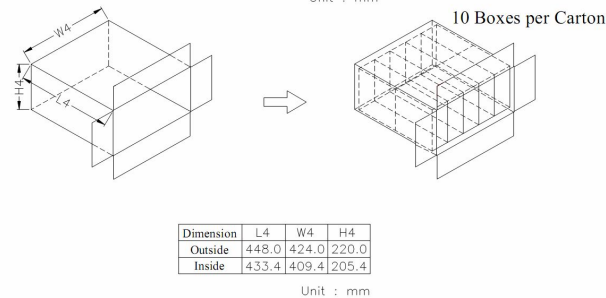
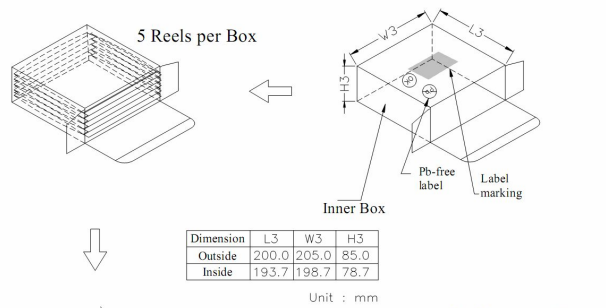
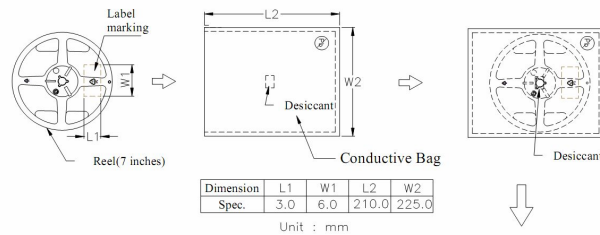
NOTES
<ol style="list-style-type: none"> 1. Empty component pockets are sealed with top cover tape; 2. The maximum number of missing lamps is two; 3. The polarity mark is oriented towards the tape sprocket hole ; 4. 3,000pcs/Reel.



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PACKAGING SPECIFICATIONS

Packaging specifications



NOTES:

Reeled products (numbers of products are 4,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums (total maximum number of products are 28,000pcs) packed in an inside box (size: about 283mm x about 194mm x about 102mm) and four inside boxes of maximums are put in the outside box (size: about 410mm x about 254mm x about 229mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.



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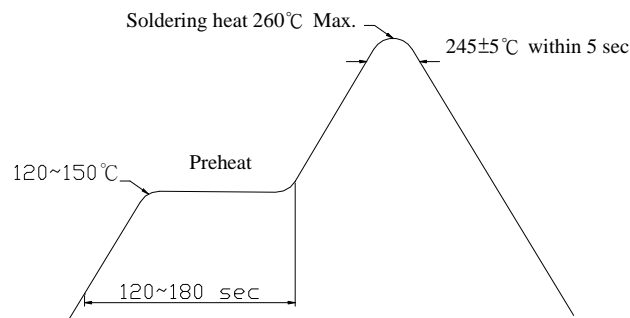
Descriptions :

The Chip-LED Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.

Besides, lightweight makes them ideal for miniature application, etc.

Soldering heat reliability (DIP) :

Please refer to the following figure :



Precautions For Use :

Over - current - proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen)

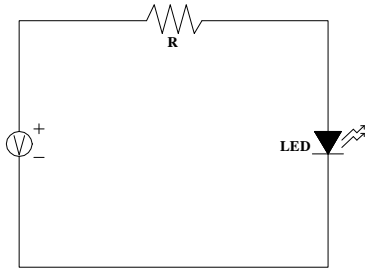
Storage

1. The operation of temperature and R.H. are : $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$, 60%R.H. Max.
2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a dampproof box with desiccating regent. Considering the tape life, we suggest our customers to use our products within 1.5 year (from production date) .
3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is : $60^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 15hrs.

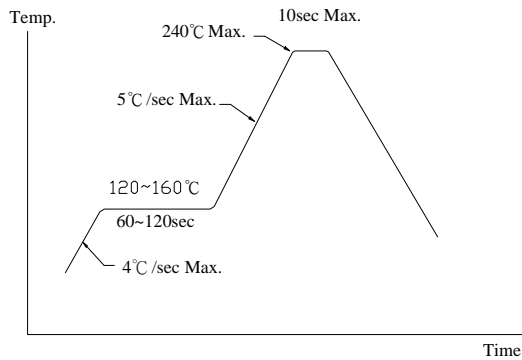


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Test Circuit



Reflow Temp. / Time :



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

No.	Items	Test Condition	Test Hours/Cycles	Sample Size
1	Solder Heat	TEMP : 260°C ±5°C	5 sec	48 pcs
2	Temperature Cycle	90°C ~ 25°C ~ -30°C ~ 25°C 30m 5m 30m 5m	300Cycles	48 Pcs
3	Thermal Shick	100°C ~ -55°C 10m 10m	100Cycles	48 Pcs
4	Operation Life	If=20mA	1000 Hrs	48 Pcs
5	High Temperature Storage	Temp:90°C	1000Hrs	48 Pcs
6	Low Temperature Storage	Temp:-30°C	1000Hrs	48 Pcs
7	High Temperature/High Humidity	80°C / R.H80%	1000Hrs	48 Pcs